R183-Z92-AAV3

Rack Server - 1U DP 12-Bay SATA/SAS







Key Features

- Dual AMD EPYC[™] 9005/9004 Series Processors
- 12-Channel DDR5 RDIMM, 24 x DIMMs
- Dual ROM Architecture
- 2 x 1Gb/s LAN ports via Intel® I350-AM2
- 12 x 2.5" SATA/SAS hot-swap bays
- 3 x M.2 slots with PCle Gen3 x4 and x2 interface
- 2 x FHHL PCIe Gen5 x16 slots
- 2 x OCP NIC 3.0 PCle Gen5 x16 slots
- Dual 1600W 80 PLUS Titanium redundant power supply

Application

Networking, Hybrid/Private Cloud Server...

Specification

Dimensions	1U (W438 x H43.5 x D815 mm)
Motherboard	MZ93-FS0
CPU	AMD EPYC™ 9005 Series Processors AMD EPYC™ 9004 Series Processors Dual processors, cTDP up to 300W - OCP NIC 3.0 ≤ 21W at 30°C ambient, cTDP up to 400W
Sock	2 x LGA 6096 (Socket SP5)
Chipset	System on Chip
Memory	12-Channel DDR5 RDIMM, 24 x DIMMs [EPYC 9005] Up to 6000 MT/s [EPYC 9004] Up to 4800 MT/s
LAN	2 x 1Gb/s LAN (1 x Intel® I350-AM2) - Supports NCSI function 1 x 10/100/1000 Mbps Management LAN
Video	Integrated in ASPEED® AST2600 - 1 x Mini-DP
Storage	Front hot-swap: 12 x 2.5" SATA/SAS *SAS card is required to support SAS drives. Internal M.2: 2 x M.2 (2280/22110), PCIe Gen3 x4 1 x M.2 (2280/22110), PCIe Gen3 x2

Require RAID add-in cards RAID

2 x FHHL PCIe Gen5 x16 slots Expansion

2 x OCP NIC 3.0 PCIe Gen5 x16 slots - Supports NCSI function

I/O Ports Front: 1 x USB 3.2 Gen1

Rear: 2 x USB 3.2 Gen1, 1 x Mini-DP, 2 x RJ45, 1 x MLAN

Backplane Board Speed and bandwidth: SATA 6Gb/s or SAS 12Gb/s

Security Modules 1 x TPM header with SPI interface

- Optional TPM2.0 kit: CTM010

Dual 1600W 80 PLUS Titanium redundant power supply Power Supply

AC Input: 100-240V

ASPEED® AST2600 Baseboard Management Controller System Management

GIGABYTE Management Console web interface

OS Support Windows Server, Red Hat Enterprise Linux server, Ubuntu. SUSE Linux Enterprise server, VMware ESXi, Citrix Hypervisor

1 x R183-Z92-AAV3, 2 x CPU heatsinks,

System Fans 8 x 40x40x56mm (32,000rpm)

Operating Operating temperature: 10°C to 35°C **Properties** Operating humidity: 8%-80% (non-condensing)

Non-operating temperature: -40°C to 60°C Non-operating humidity: 20%-95% (non-condensing)

1 x Mini-DP to D-Sub cable, 1 x 2-Section Rail kit Content Packaging Dimensions: 1045 x 595 x 249 mm

Part Numbers Barebone package: 6NR183Z92DR000ACV3*

Optional parts:

- 3-Section Rail kit (Supports CMA): 25HB2-A56121-K0R
- Cable Management Arm: 25HB1-R18300-K0R
- RMA packaging: 6NR183Z92SR-RMA-A100



Learn more at https://www.GIGABYTE.com/enterprise

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Packaging

